Semiconductor & Microelectronic Assembly

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Dual Rollers Breaker Model BRK-60R

Thin Glass Borosilicate Silicon Alumina Sapphire And more...



WAFER BREAKER BRK-60R is easy to use for singulating very small components, up to 2.5x2.5" wafer or substrate Robust; the Breaker unit is immediately operational, with minimum training. Vertical targeting is carried out with a video camera, for angular alignment. Monitor display includes an electronic crosshair. All parameters are directly adjusted on operator control panel.

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Specifications	
MODEL:	❖Automatic dual roller breaker BRK-60R
Breaker Head	 2 Rollers, length 105mm Roller Force; independently adjustable for X & Y Floating Rollers for Parallelism X & Y Table motorized Z axis, Air Cylinder
WAFER TABLE	 Workholder up to 60mmx60mm wafer X & Y travel up to 100mmx100mm Parts shield holded by vacuum Rotary chuck for theta alignment Rotation alignment by micrometric screw Micrometer to adjust Theta
VISION SYSTEM	 Optics & magnification compatible with application (1 to 4x) Alignment: Programmable area / Manual TFT monitor 17" and CCD color camera high definition Target generator LED lightings
PARAMETERS	 Break mode: Single or Dual breaking pass on X or Y axis Breaking Force adjustable on X & Y rollers X break speed, electronic control Y break speed, electronic control
UTILITIES	 Power 100Vac to 230Vac / 50W Vacuum: 60% Air:70psi Vacuum:70% Dimensions:480x555x6200mm Weight:30 kg



Breaking Sequence

